STL4LN80K5



N-channel 800 V, 2.1 Ω typ., 2 A MDmesh™ K5 Power MOSFET in a PowerFLAT™ 5x6 VHV package

Datasheet - production data

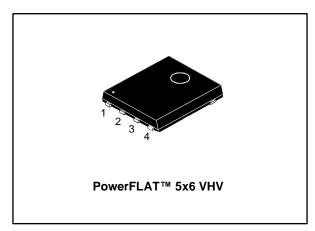
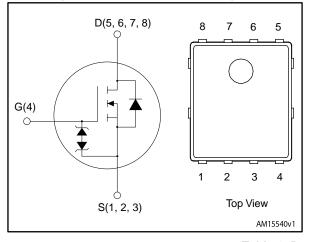


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ΙD
STL4LN80K5	800 V	2.6 Ω	2 A

- Industry's lowest R_{DS(on)} * area
- Industry's best FoM (figure of merit)
- Ultra low-gate charge
- 100 % avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STL4LN80K5	4LN80K5	PowerFLAT™ 5x6 VHV	Tape and reel

Contents STL4LN80K5

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STL4LN80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	± 30	V
I _D	Drain current (continuous) at T _C = 25 °C	2	Α
ΙD	Drain current (continuous) at T _C = 100 °C	1.2	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	8	Α
P _{TOT}	Total dissipation at T _C = 25 °C	38	W
dv/dt (2)	Peak diode recovery voltage slope	4.5	1//
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature range	- 55 to 150	°C
T _{stg}	Storage temperature range	- 55 (0 150	°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	3.3	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	59	°C/W

Notes

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by Tjmax)	0.8	Α
E _{AS}	Single pulse avalanche energy (starting Tj = 25 °C, I _D = I _{AR} , V _{DD} = 50 V)	160	mJ

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}I_{SD} \le 2$ A, $dv/dt \le 100$ A/ μ s; V_{DS} peak $< V_{(BR)DSS}$

 $^{^{(3)}}V_{DS} \le 640 \text{ V}$

 $^{^{(1)}}$ When mounted on FR-4 board of 1 inch², 2 oz Cu

Electrical characteristics STL4LN80K5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			V
		$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$			50	μΑ
Igss	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 1.25 A		2.1	2.6	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		ı	110	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	ı	9.5	-	pF
Crss	Reverse transfer capacitance	V65 - 0 V	ı	0.4	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	V _{DS} = 0 to 640 V,	1	23	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	V _{GS} = 0 V	ı	9	-	pF
Rg	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	18	-	Ω
Q_g	Total gate charge	$V_{DD} = 640 \text{ V}, I_{D} = 2.5 \text{ A}$	-	3.7	-	nC
Qgs	Gate-source charge	$V_{GS} = 0 \text{ to } 10 \text{ V},$	-	1	-	nC
Q_{gd}	Gate-drain charge	see Figure 15: "Test circuit for gate charge behavior"	-	2.2	-	nC

Notes

⁽¹⁾Defined by design, not subject to production test.

 $^{^{(1)}}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80 % V_{DSS}.

 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when VDS increases from 0 to 80 % V_{DSS}.

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 400 V, I_{D} = 1.25 A, R_{G} = 4.7 Ω	ı	7	1	ns
tr	Rise time	V _{GS} = 10 V	ı	9	ı	ns
t _{d(off)}	Turn-off delay time	(See Figure 14: "Test circuit for resistive load switching times" and	-	31	-	ns
t _f	Fall time	Figure 19: "Switching time waveform")	-	25	-	ns

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		ı		2	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		ı		8	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 2 A, V _{GS} = 0 V	ı		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 2.5 A, di/dt = 100 A/µs,	ı	230		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V, (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	1.04		μC
I _{RRM}	Reverse recovery current		1	9		А
t _{rr}	Reverse recovery time	I _{SD} = 2.5 A, di/dt = 100 A/µs, V _{DD} = 60 V, T _j = 150 °C (see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	368		ns
Qrr	Reverse recovery charge		1	1.53		μC
I _{RRM}	Reverse recovery current		-	8		А

Notes:

Table 9: Gate source-Zener diode

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit.
$V_{(BR)GS0}$	Gate-source breakdown voltage	I _{GS} = ± 1mA, I _D = 0 A	30	-	-	V

The built-in back-to-back Zener diodes have specifically been designed to enhance the device's ESD capability. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.



⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)

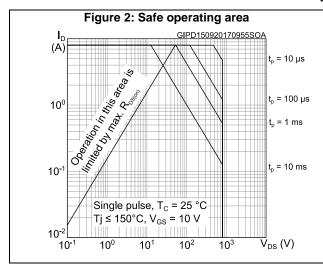
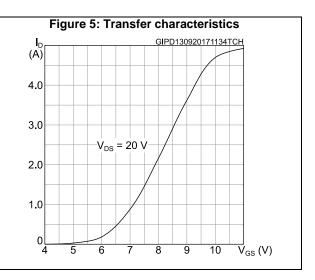
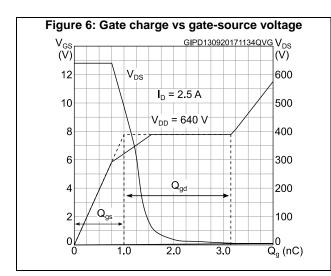
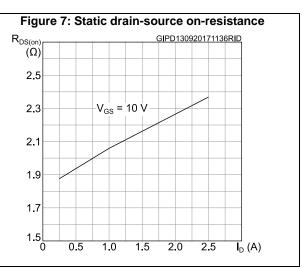


Figure 4: Output characteristics GIPD130920171132OCH **I**_D (A) V_{GS} = 11 V $V_{GS} = 10 \text{ V}$ 4.0 $V_{GS} = 9 V$ 3.0 $V_{GS} = 8 V$ 2.0 $V_{GS} = 7 V$ 1.0 $V_{GS} = 6 V$ 8 12 $\overline{V}_{DS}(V)$



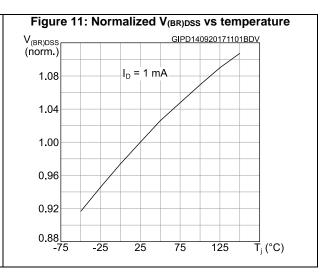


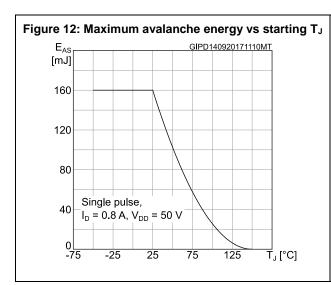


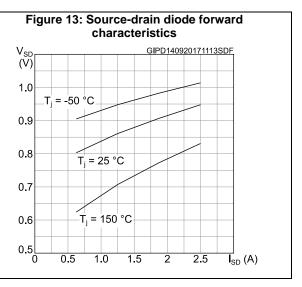
STL4LN80K5 Electrical characteristics

Figure 8: Capacitance variations GIPD130920171151CVR (pF) 10^{3} C_{ISS} 10² Coss 10¹ C_{RSS} 10⁰ 10⁻¹ 10 10⁰ 10¹ 10² $\vec{V}_{DS}(V)$

Figure 10: Normalized on-resistance vs temperature R_{DS(on)} (norm.) GIPD140920171100RON 2.6 2.2 1.8 V_{GS} = 10 V 1.4 1.0 0.6 0.2 -75 75 -25 25 125 T_i (°C)







Test circuits STL4LN80K5

3 Test circuits

Figure 14: Test circuit for resistive load switching times

Volume 14: Test circuit for resistive load switching times

Figure 15: Test circuit for gate charge behavior

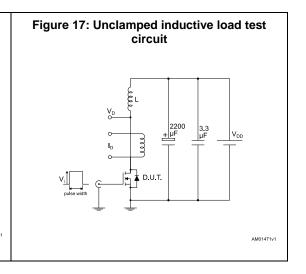
V_S

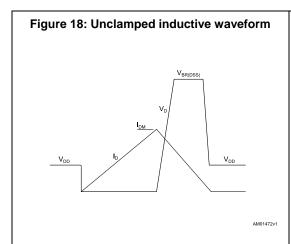
Pulse width

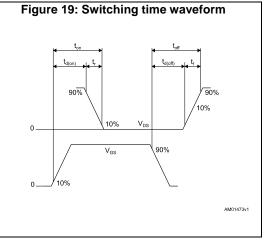
2200

PF

AM01469v10







STL4LN80K5 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 PowerFLAT™ 5x6 VHV package information

Figure 20: PowerFLAT™ 5x6 VHV package outline

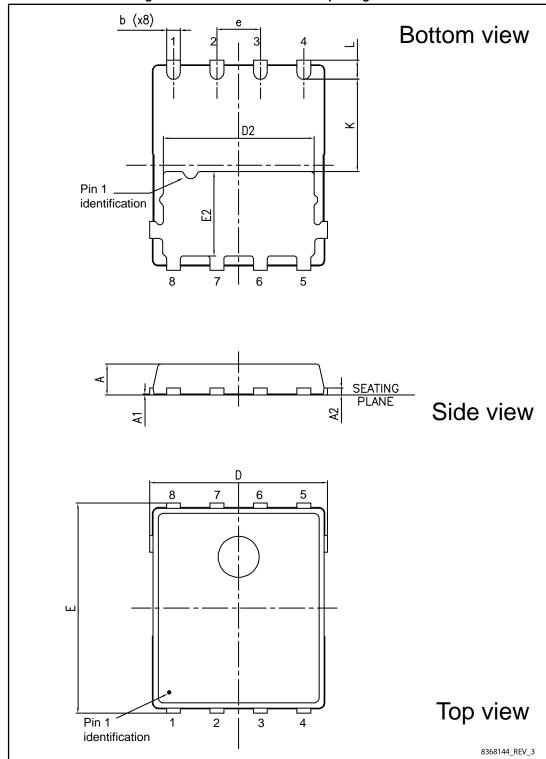
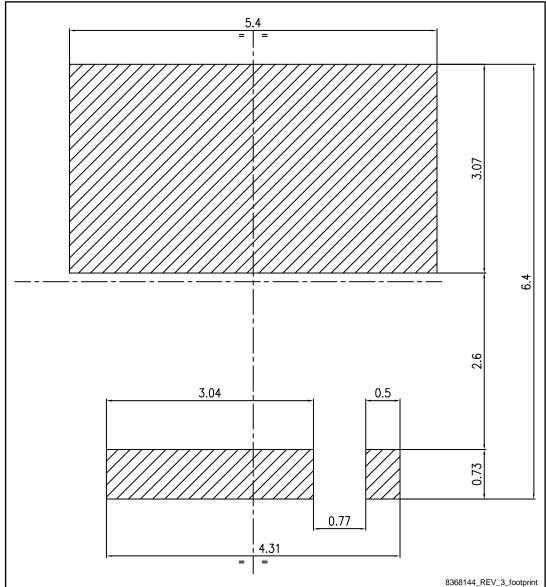


Table 10: PowerFLAT™ 5x6 VHV package mechanical data

Dim.			
Dilli.	Min.	Тур.	Max.
А	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
D	5.00	5.20	5.40
Е	5.95	6.15	6.35
D2	4.30	4.40	4.50
E2	2.40	2.50	2.60
е		1.27	
L	0.50	0.55	0.60
K	2.60	2.70	2.80





STL4LN80K5 Package information

4.2 PowerFLAT™ 5x6 packing information

Figure 22: PowerFLAT™ 5x6 tape (dimensions are in mm)

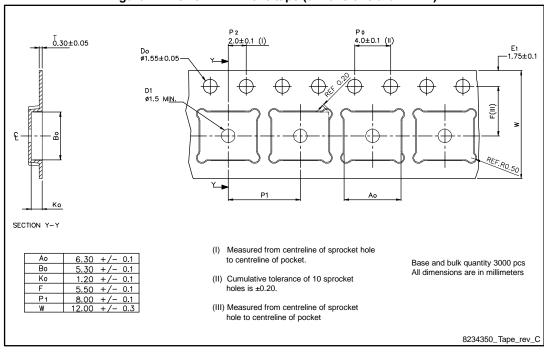


Figure 23: PowerFLAT™ 5x6 package orientation in carrier tape

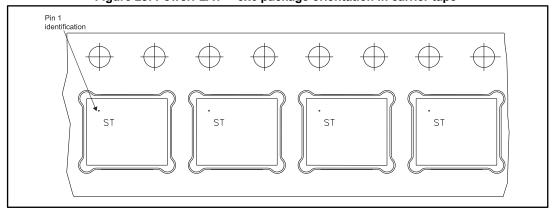


Figure 24: PowerFLAT™ 5x6 reel

PART NO.

R25.00

R25.

STL4LN80K5 Revision history

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
29-May-2015	1	First release.
02-Oct-2017	2	Updated title and features in cover page. Updated Section 1: "Electrical ratings", Section 2: "Electrical characteristics". Added Section 2.1: "Electrical characteristics (curves)". Minor text changes.

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